



LPTM10 New Mask Set Yield and Parametric Analysis

November 2015

The LPTM10 (also known as Platform Manager) is a dual-die power manager product that consists of a LCMXO640C and ispPAC-POWR1220AT8.

Changes were made to each of the respective die that needed to be validated for use in the LPTM10. Those changes were:

1. LCMXO product family was transferred from Fujitsu's 200mm Mie fab to the adjacent 300mm fab. This change was detailed in [PCN 05A-14](#) on June 9, 2014.
2. The ispPAC-POWR1220AT8 and other POWR devices were dual sourced from UMC to the Seiko-Epson fab in Sakata, Japan. This change was detailed in [PCN 01A-12](#) on January 23, 2012
3. Additionally, the mold compound for the TQFP version was changed.

The above changes have been designated as LPTM10 design revision "B". An engineering build incorporating all the above changes was built and characterized. This report is a summary of those findings.

Product-Package-Revision	Package (Mold Compound)	LCMXO640C	ispPAC-POWR1220AT8
LPTM10-12107 "A"	208ftBGA	LCMXO640C (200mm)	ispPAC-POWR1220AT8 (UMC)
LPTM10-12107 "B"	208ftBGA (no change)	LCMXO640C (300mm)	ispPAC-POWR1220AT8 (Seiko)
LPTM10-1247 "A"	128TQFP CEL-9510HFL-U	LCMXO640C (200mm)	ispPAC-POWR1220AT8 (UMC)
LPTM10-1247 "B"	128TQFP Sumitomo EME-G631SH	LCMXO640C (300mm)	ispPAC-POWR1220AT8 (Seiko)

SUMMARY OF RESULTS / FINDINGS



				Class Test #1			Class Test #1	
Device Name	Package	Mask Set	Lot #	Tester	Qty In	Yield	Tester	Yield
LPTM10-12107	208BGA	B New	CX4123AE1	Nextest	2417	1.006	Eagle	1.021
		A Old	Production Average		20655	1.000	Eagle	1.000
LPTM10-1247	128TQFP	B New	CX4122AZE1	Nextest	2424	1.001	Eagle	1.006
		A Old	Production Average		7660	1.000	Eagle	1.000

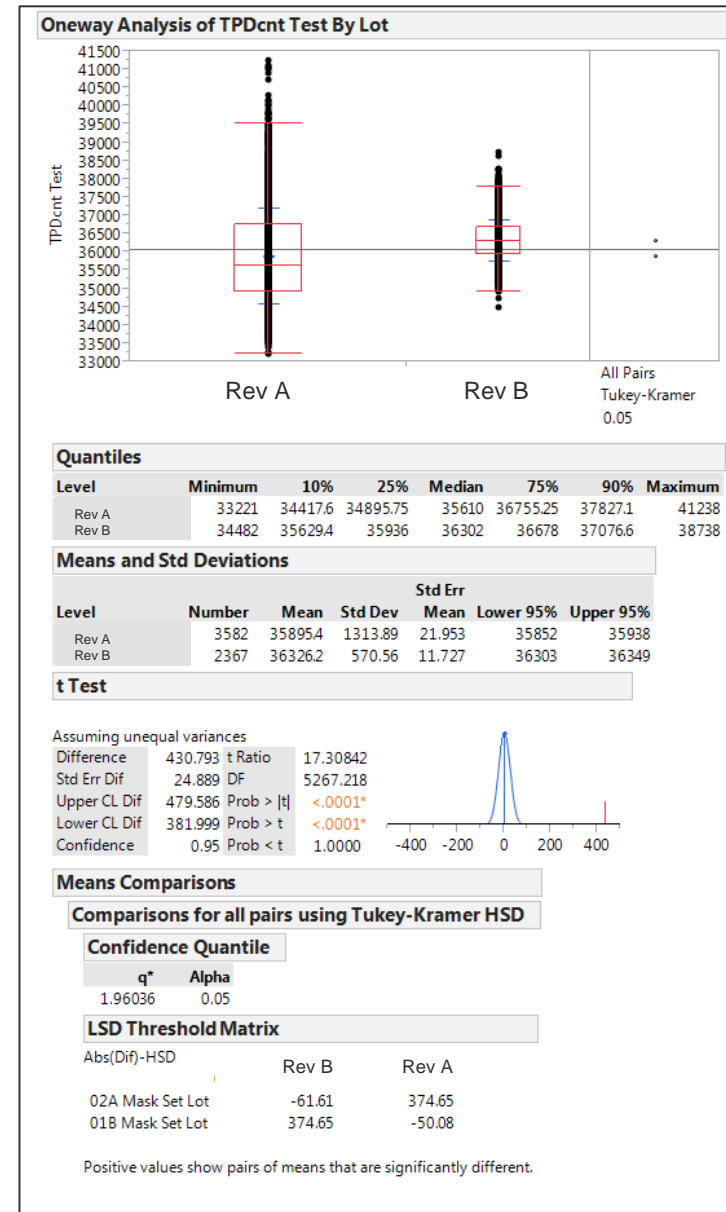
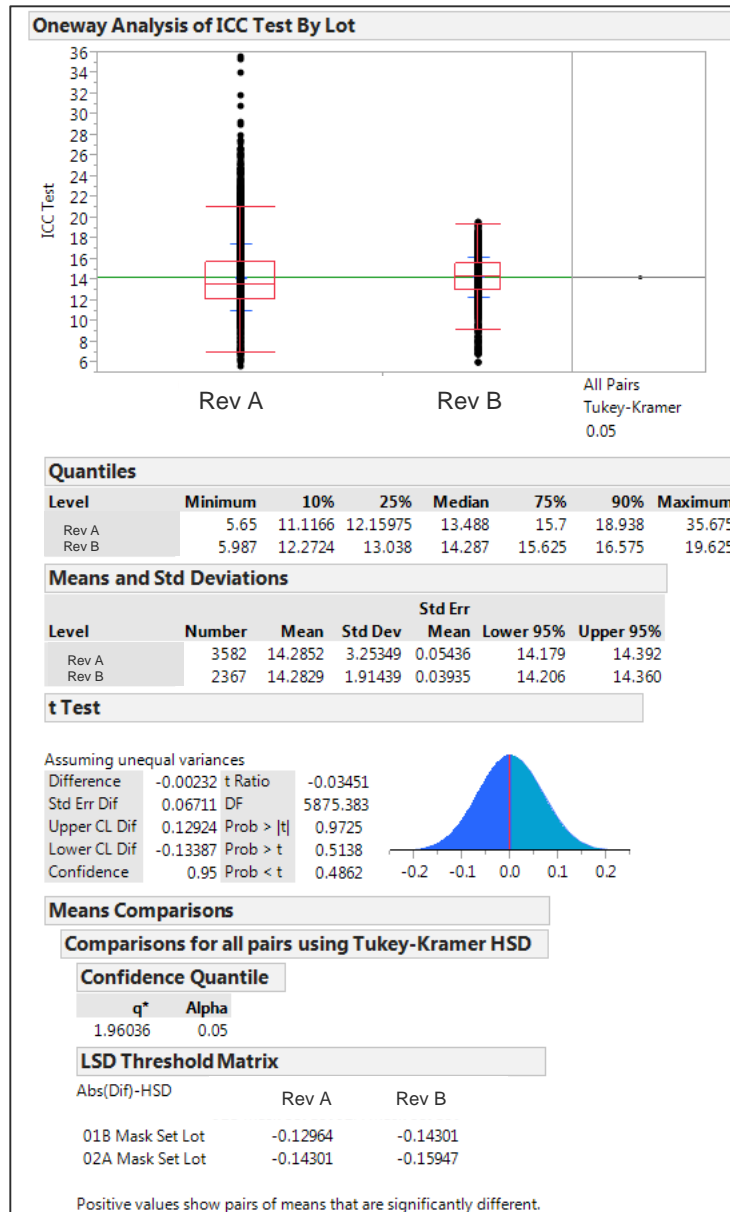
- Test yields are slightly better for the rev B die combination for both package types.

				Nextest				Eagle							
				Icc		Tpd		Icc		ILeak 5.5 VMON		ILeak 14V od HV		HV VP 12V	
Device Name	Package	Mask Set	Lot #	Mean	StdDev	Mean	StdDev	Mean	StdDev	Mean	StdDev	Mean	StdDev	Mean	StdDev
LPTM10-12107	208BGA	B New	CX4123AE1	14.28	1.91	36326	570.56	32.49	0.35	83.22	1.28	45.57	0.6	11.93	0.05
		A Old	Production Average	14.29	3.25	35895	1313.89	33.37	0.43	92.15	1.38	45.68	1.26	11.96	0.05
LPTM10-1247	128TQFP	B New	CX4122AZE1	14.82	1.09	35055	474.71	32.94	0.39	86.02	1.4	47.11	0.66	11.94	0.04
		A Old	Production Average	17.02	3.63	34881	1358.04	33.63	0.46	94.74	1.04	45.67	0.66	11.92	0.05

- Critical Parametric comparison shows that new rev B die combination has better Mean and STDev compared to old/current rev A die combination. Results suggest that we can release rev B to production.

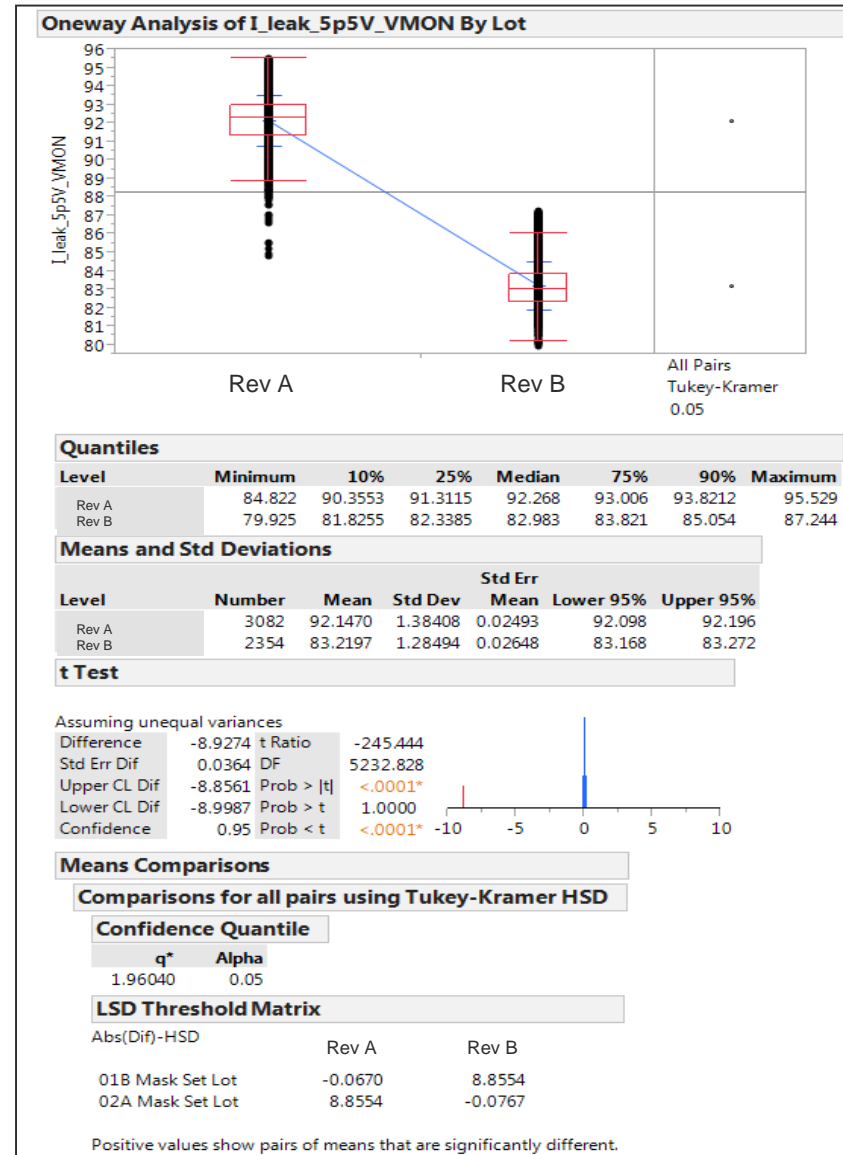
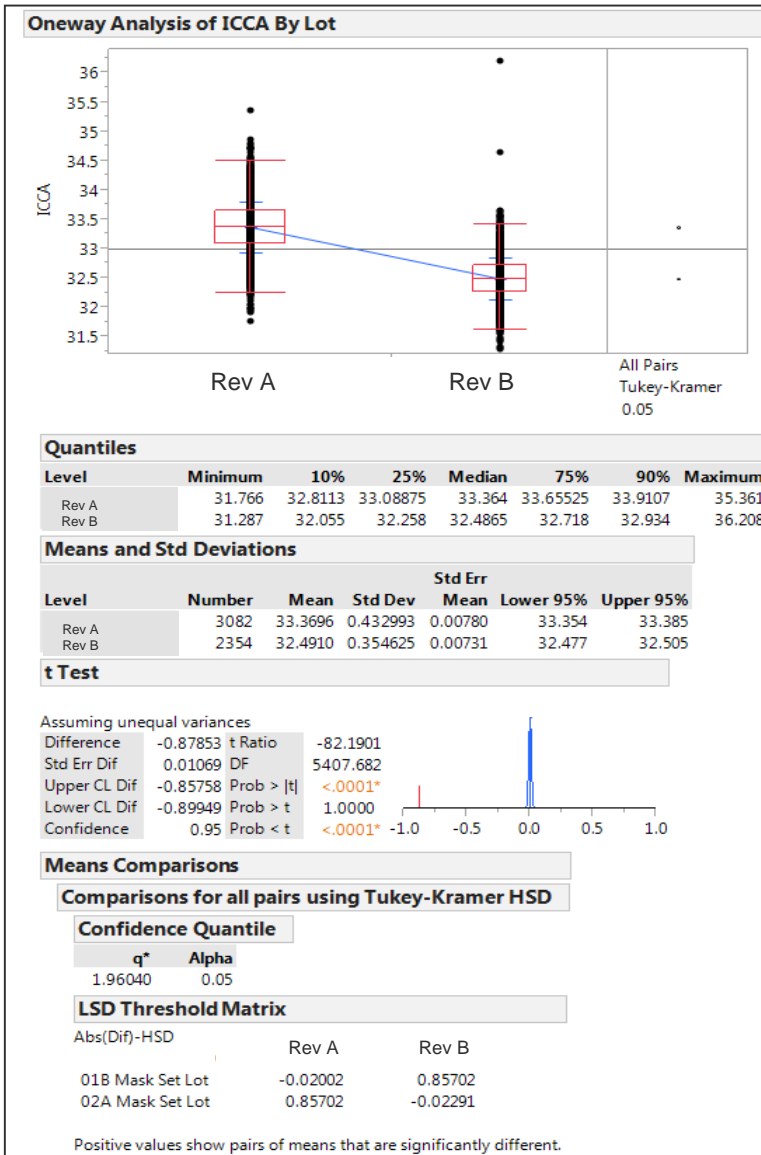
ONEWAY ANALYSIS – PARAMETRIC TEST

NEXTEST TESTER – FTG208



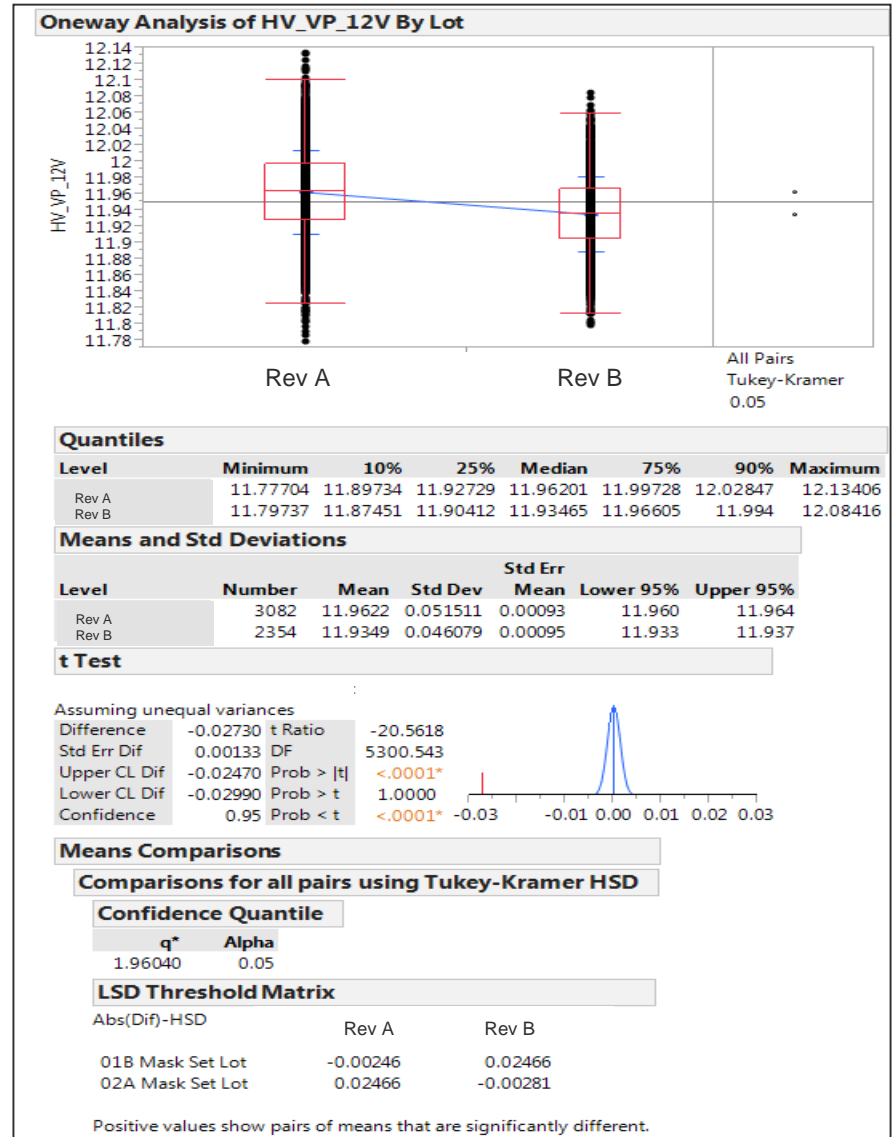
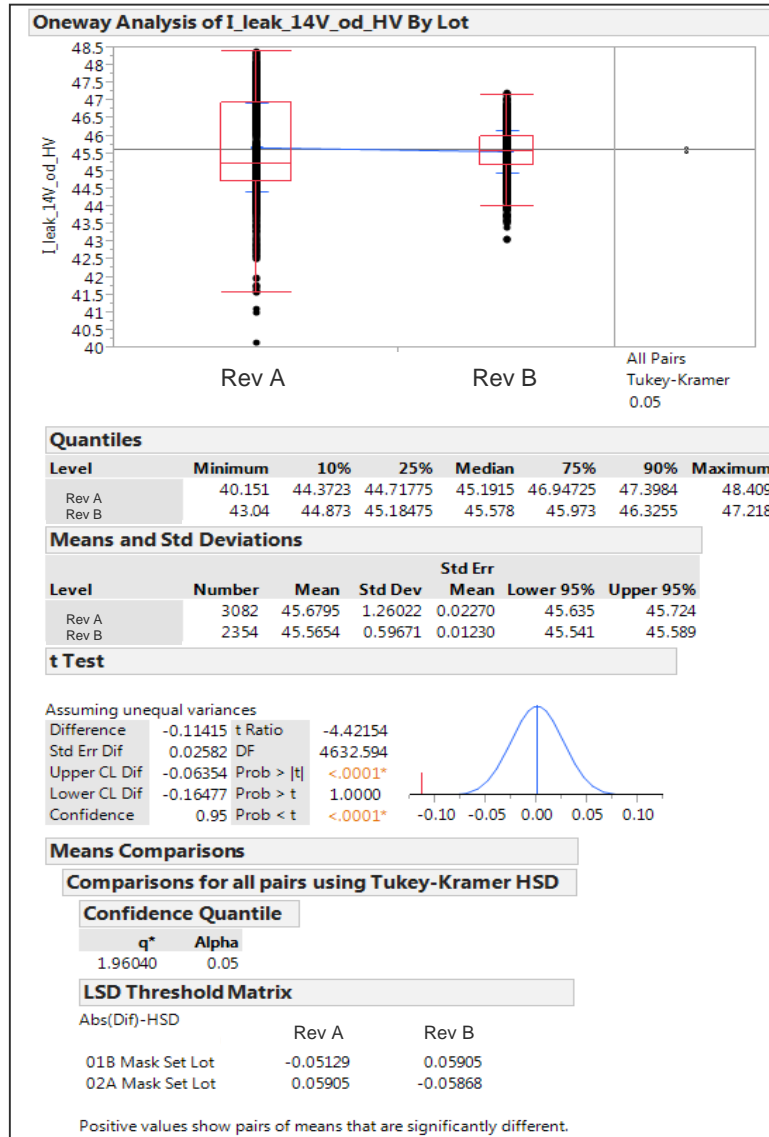
ONEWAY ANALYSIS – PARAMETRIC TEST

ETS TESTER – FTG208



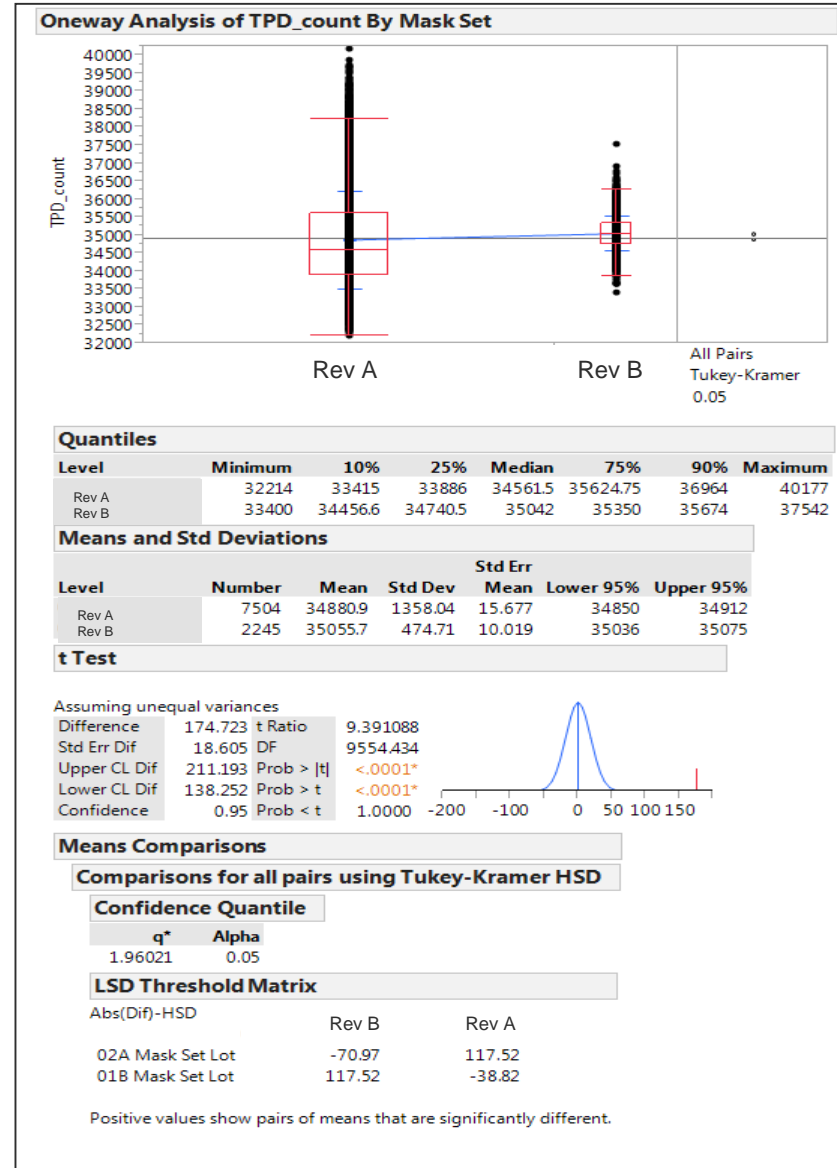
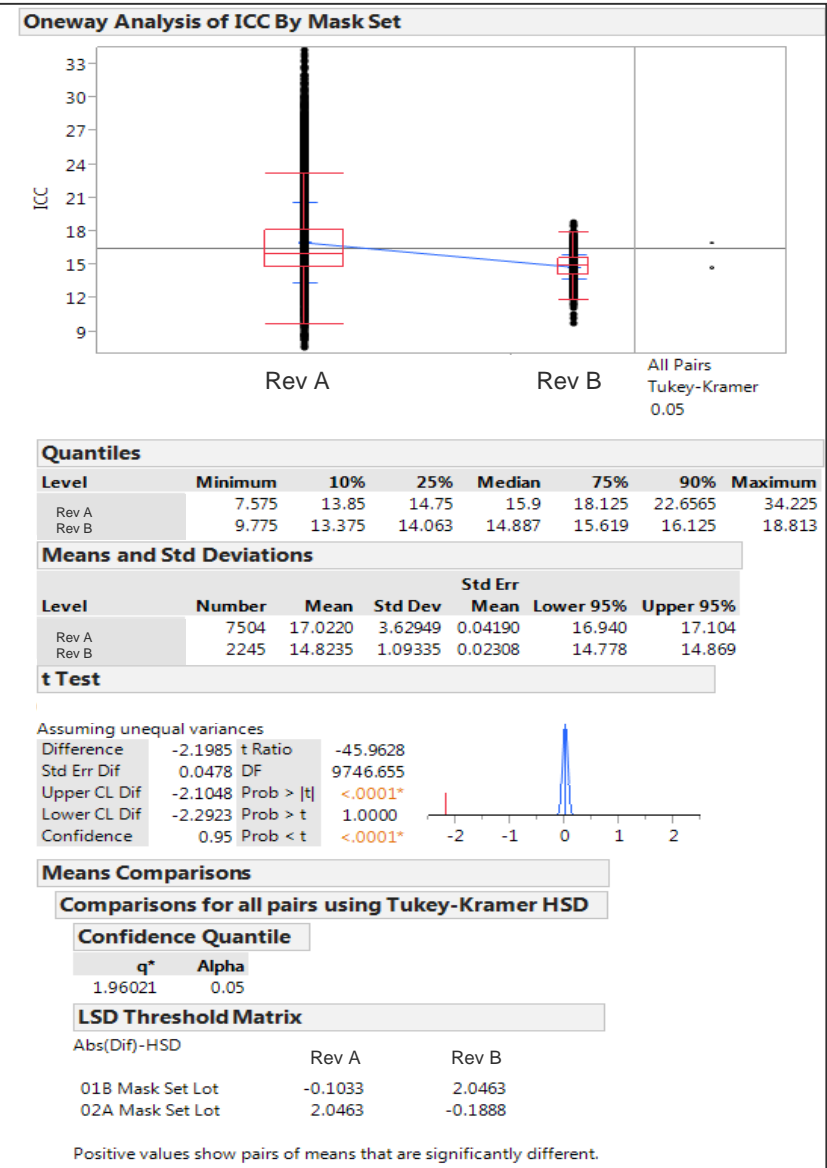
ONEWAY ANALYSIS – PARAMETRIC TEST

ETS TESTER – FTG208



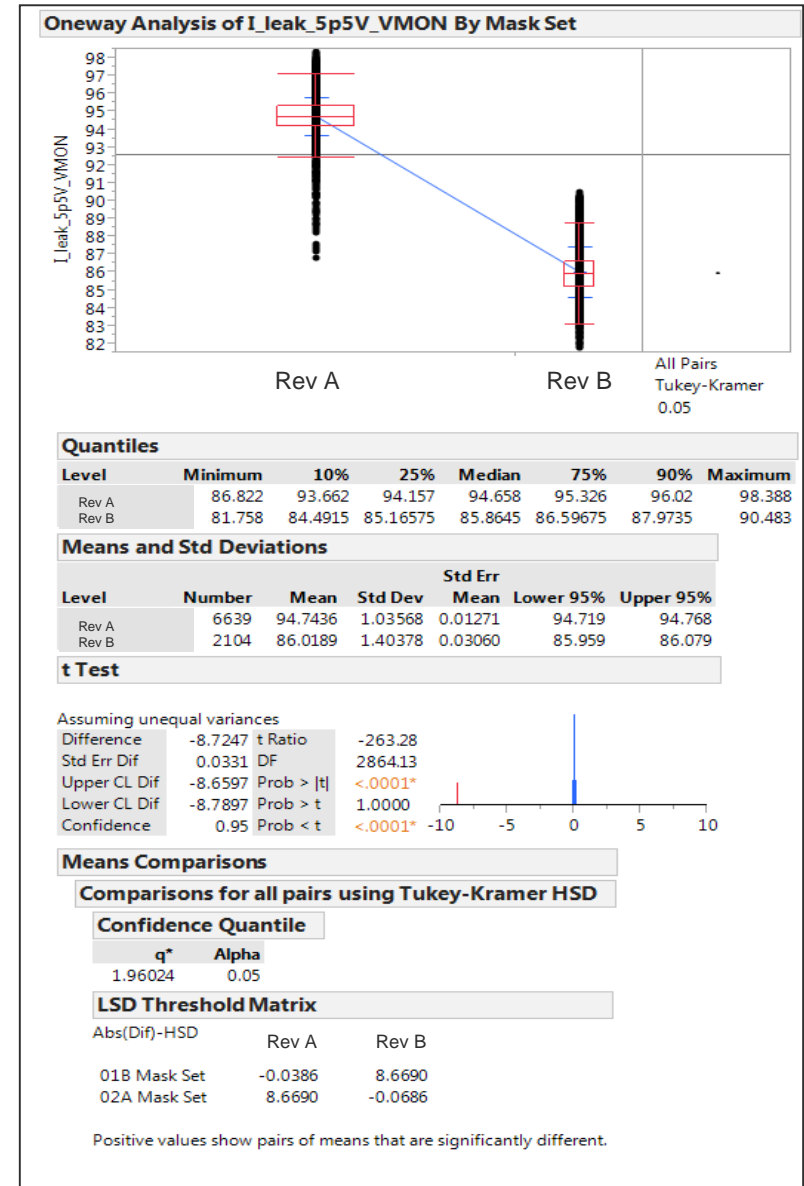
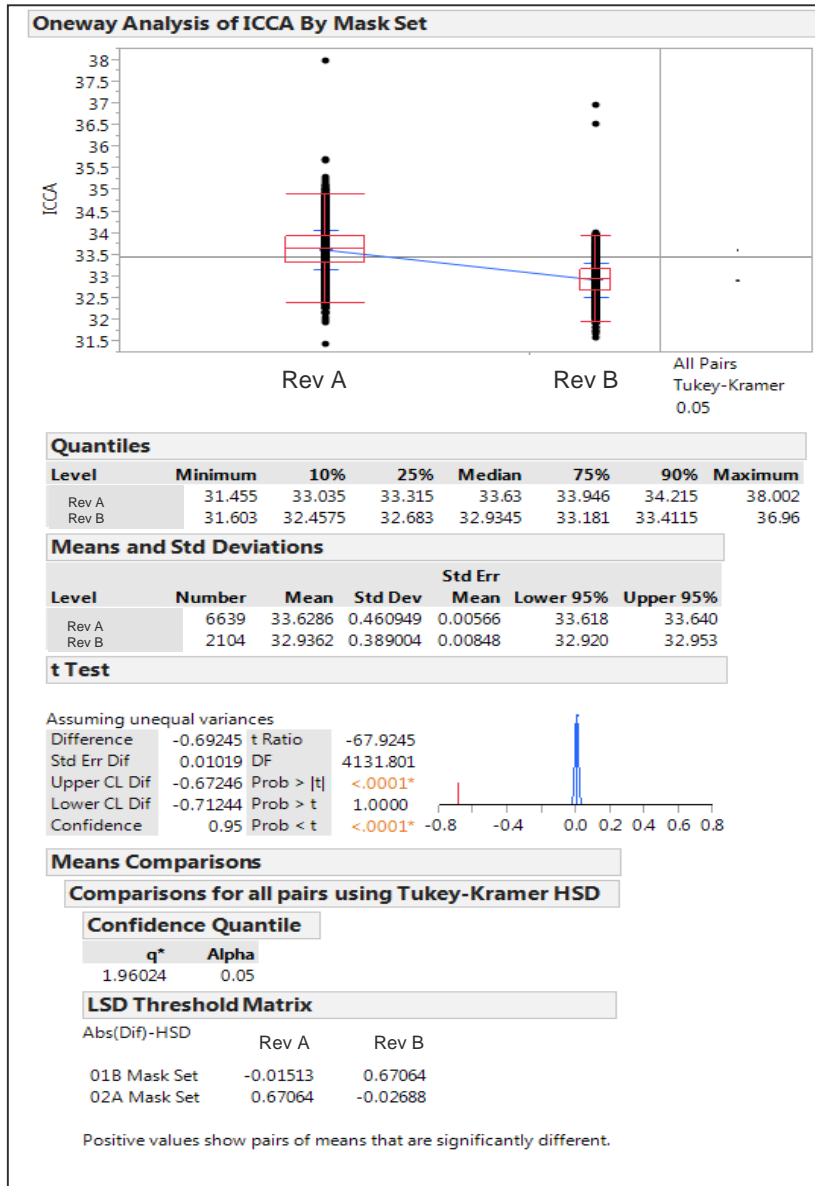
ONEWAY ANALYSIS – PARAMETRIC TEST

NEXTEST TESTER – TG128



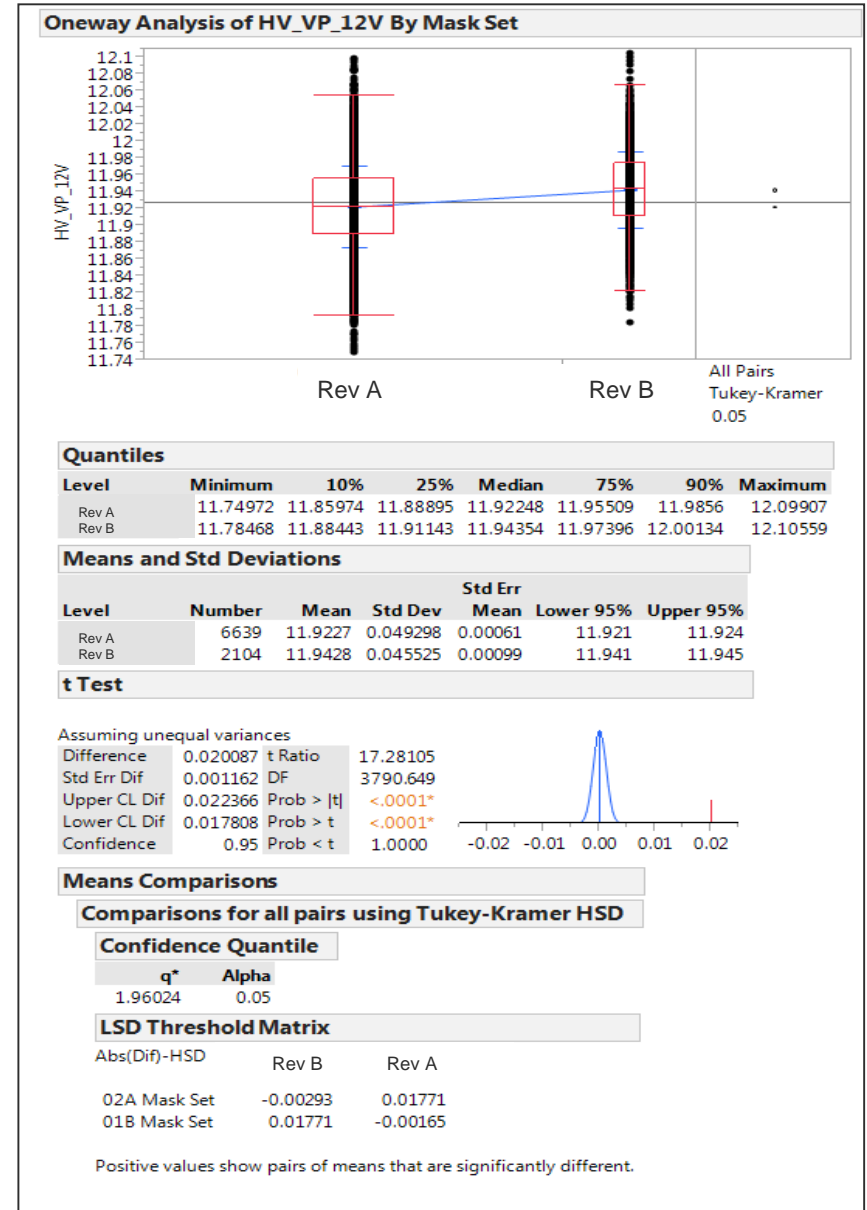
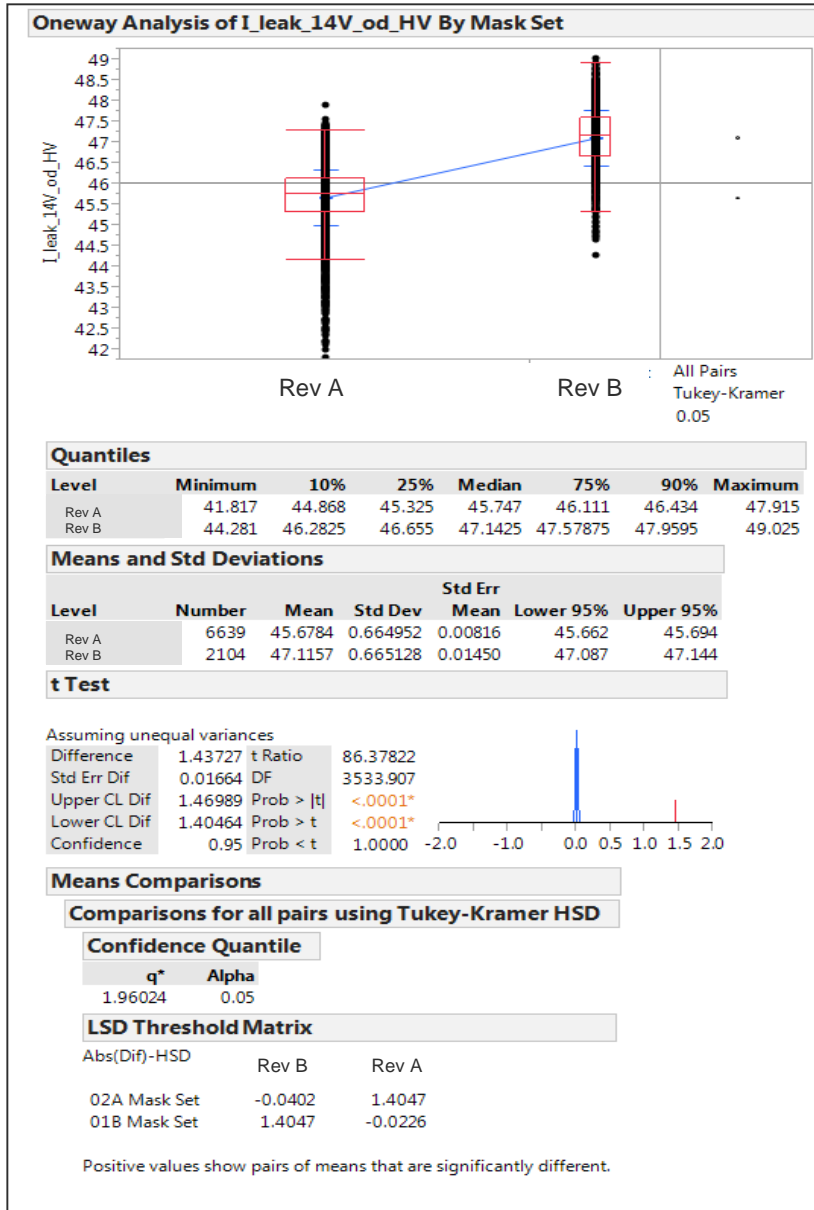
ONEWAY ANALYSIS – PARAMETRIC TEST

ETS TESTER – TG128



ONEWAY ANALYSIS – PARAMETRIC TEST

ETS TESTER – TG128



Since the two die that make up the LPTM10 have been previously characterized and released, it was highly likely that the combination were also production-worthy.

An analysis of yield and parametric data from two engineering builds confirms that the LPTM10 operates within expected parameters. Rev "B" seems to have slightly better mean parametric values and tighter standard deviations but the difference is not statistically significant.

The LPTM10 "B" mask set is recommended for production release.